

03-29-2001



RECOR

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FORM PTO-1595 (Rev. 6-93) OMB No 0651-0011 (exp 4/94) M&G- 10873.398USII

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<p>1. Name of conveying party(ies):</p> <p>Daizou Andou (February 21, 2001) <i>3-13-01</i> Toshio Sugawa (February 21, 2001) Tadashi Nakamura (February 21, 2001) Hideki Higashitani (February 21, 2001) Masahide Tsukamoto (February 21, 2001)</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party(ies):</p> <p>Matsushita Electric Industrial Co., Ltd. 1006-banchi, Oaza-Kadoma Kadoma-shi, Osaka 571-8501 Japan</p> <p><i>MAR 13 2001</i></p> <p>Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
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3. Nature of conveyance:

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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s) B. Patent No.(s)

09/728286

5. Name and address of party to whom correspondence concerning document should be mailed: Additional numbers attached? Yes No

Name: Douglas P. Mueller
Address: P.O. Box 2903
Minneapolis, MN 55402-0903
(612) 332-5300

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): Enclosed Authorized to be charged to deposit account

8. Please charge any additional fees or credit any overpayments to our Deposit account number: 13-2725

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9. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Douglas P. Mueller *[Signature]* March 9, 2001

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PATENT
REEL: 011619 FRAME: 0920

INSTRUCTIONS

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS,

Inventor(s) Name,
Address, Citizenship

1. Daizou Andou residing at 4-9-8, Hoshidanishimachi, Katano-shi, Osaka 576-0015, Japan and a citizen of Japan;
2. Toshio Sugawa residing at 5-10-27, Fujigao, Katano-shi, Osaka 576-0022, Japan and a citizen of Japan;
3. Tadashi Nakamura residing at 9-25-101, Naganonishi, Suita-shi, Osaka 565-0817, JAPAN and a citizen of Japan;
4. Hideki Higashitani residing at 11-5, Kizugawadai 7-chome, Kizu-cho, Souraku-gun, Kyoto 619-0225, JAPAN and a citizen of Japan;
5. Masahide Tsukamoto residing at 30-14, Tomiozumigaoka, Nara-shi, Nara 631-0051, Japan and a citizen of Japan;

Date Patent Declaration
Signed and Title Serial
No. and filing date (if
known)

(herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on _____ for this invention, which application is entitled CIRCUIT BOARD AND METHOD OF MANUFACTURING THE SAME and which has been given Serial Number 09/728,286 and the filing date of December 1, 2000;

Name of Corporation

AND WHEREAS Matsushita Electric Industrial Co., Ltd. (herein called "ASSIGNEE"), a corporation organized under the laws of Japan, and having an office and place of business at 1006-banchi, Oaza-Kadoma, Kadoma-shi, Osaka 571-8501, Japan

State or Country of
Incorporation and Address

wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents. and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each inventor must sign & date

Daijou Andou
Signature

February 21, 2001
Date

Note: No legalization or other witness required

Toshio Sugawara
Signature

February 21, 2001
Date

Tadashi Nakamura
Signature

February 21, 2001
Date

Hideki Higashitani
Signature

February 21, 2001
Date

Masahide Tsukamoto
Signature

February 21, 2001
Date